# 100 mA, 5.0 V, Low Dropout Voltage Regulator with Reset and Sense

The L4949 is a monolithic integrated 5.0 V voltage regulator with a very low dropout and additional functions such as reset and an uncommitted voltage sense comparator.

It is designed for supplying microcontroller/microprocessor controlled systems particularly in automotive applications.

#### **Features**

- Operating DC Supply Voltage Range 5.0 V to 28 V
- Transient Supply Voltage Up to 40 V
- Extremely Low Quiescent Current in Standby Mode
- High Precision Output Voltage 5.0 V ±1%
- Output Current Capability Up to 100 mA
- Very Low Dropout Voltage Less Than 0.4 V
- Reset Circuit Sensing The Output Voltage
- Programmable Reset Pulse Delay
- Voltage Sense Comparator
- Thermal Shutdown and Short Circuit Protections
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- These are Pb-Free Devices

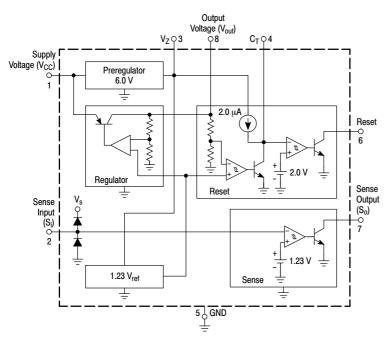


Figure 1. Representative Block Diagram



## ON Semiconductor®

http://onsemi.com

#### **MARKING DIAGRAMS**



PDIP-8 N SUFFIX CASE 626





SOIC-8 D SUFFIX CASE 751



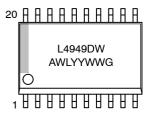


SOIC-8 EP PD SUFFIX CASE 751AC



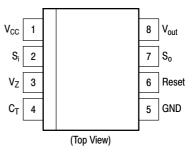


SOIC-20W DW SUFFIX CASE 751D



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or = Pb-Free Device

#### **PIN CONNECTIONS**



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
DC Operating Supply Voltage	V <sub>CC</sub>	28	V
Transient Supply Voltage (t < 1.0 s)	V <sub>CC TR</sub>	40	V
Output Current	I <sub>out</sub>	Internally Limited	-
Output Voltage	V <sub>out</sub>	20	V
Sense Input Current	I <sub>SI</sub>	±1.0	mA
Sense Input Voltage	V <sub>SI</sub>	V <sub>CC</sub>	-
Output Voltages Reset Output Sense Output	V <sub>Reset</sub> V <sub>SO</sub>	20 20	V
Output Currents Reset Output Sense Output	I <sub>Reset</sub>	5.0 5.0	mA
Preregulator Output Voltage	V <sub>Z</sub>	7.0	V
Preregulator Output Current	I <sub>Z</sub>	5.0	mA
ESD Protection at any pin Human Body Model Machine Model	- -	2000 400	V
Thermal Resistance, Junction-to-Air P Suffix, DIP-8 Plastic Package, Case 626 D Suffix, SOIC-8 Plastic Package, Case 751 PD Suffix, SOIC-8 EP Plastic Package, Case 751AC (Note 1) D Suffix, SOIC-20 Plastic Package, Case 751D	$R_{ heta JA}$	100 200 85 80	°C/W
Operating Junction Temperature Range	TJ	-40 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## **ELECTRICAL CHARACTERISTICS** ( $V_{CC}$ = 14 V, $-40^{\circ}C$ < $T_A$ < 125°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (T <sub>A</sub> = 25°C, I <sub>out</sub> = 1.0 mA)	V <sub>out</sub>	4.95	5.0	5.05	V
Output Voltage (6.0 V < V <sub>CC</sub> < 28 V, 1.0 mA < I <sub>out</sub> < 50 mA)	V <sub>out</sub>	4.9	5.0	5.1	V
Output Voltage (V <sub>CC</sub> = 35 V, t < 1.0 s, 1.0 mA < I <sub>out</sub> < 50 mA)	V <sub>out</sub>	4.9	5.0	5.1	V
Dropout Voltage  I <sub>out</sub> = 10 mA  I <sub>out</sub> = 50 mA  I <sub>out</sub> = 100 mA	$V_{ m drop}$	- - -	0.1 0.2 0.3	0.25 0.40 0.50	V
Input to Output Voltage Difference in Undervoltage Condition (V <sub>CC</sub> = 4.0 V, I <sub>out</sub> = 35 mA)	V <sub>IO</sub>	-	0.2	0.4	V
Line Regulation (6.0 V < V <sub>CC</sub> < 28 V, I <sub>out</sub> = 1.0 mA)	Reg <sub>line</sub>	-	1.0	20	mV
Load Regulation (1.0 mA < I <sub>out</sub> < 100 mA)	Reg <sub>load</sub>	-	8.0	30	mV
Current Limit Vout = 4.5 V Vout = 0 V	I <sub>Lim</sub>	105 -	200 100	400 -	mA
Quiescent Current (I <sub>out</sub> = 0.3 mA, T <sub>A</sub> < 100°C)	I <sub>QSE</sub>	ı	150	260	μΑ
Quiescent Current (I <sub>out</sub> = 100 mA)	IQ	_	_	5.0	mA

<sup>1.</sup> Soldered to a 200 mm<sup>2</sup> 1 oz. copper-clad FR-4 board.

# $\textbf{ELECTRICAL CHARACTERISTICS (continued)} \ \, (\text{V}_{CC} = 14 \ \text{V}, -40 ^{\circ}\text{C} < \text{T}_{A} < 125 ^{\circ}\text{C}, \text{ unless otherwise specified.})$

Characteristic	Symbol	Min	Тур	Max	Unit
RESET		•	•	•	
Reset Threshold Voltage	V <sub>Resth</sub>	-	V <sub>out</sub> – 0.5	_	V
Reset Threshold Hysteresis  @ T <sub>A</sub> = 25°C  @ T <sub>A</sub> = -40 to +125°C	V <sub>Resth,hys</sub>	50 50	100 -	200 300	mV
Reset Pulse Delay ( $C_T$ = 100 nF, $t_R \ge$ 100 $\mu s$ )	t <sub>ResD</sub>	55	100	180	ms
Reset Reaction Time (C <sub>T</sub> = 100 nF)	t <sub>ResR</sub>	-	5.0	30	μs
Reset Output Low Voltage (RReset = 10 k $\Omega$ to Vout, VCC $\geq$ 3.0 V)	V <sub>ResL</sub>	_	-	0.4	V
Reset Output High Leakage Current (V <sub>Reset</sub> = 5.0 V)	I <sub>ResH</sub>	-	-	1.0	μΑ
Delay Comparator Threshold	V <sub>CTth</sub>	-	2.0	-	V
Delay Comparator Threshold Hysteresis	V <sub>CTth, hys</sub>	_	100	-	mV
SENSE		•			
Sense Low Threshold (V <sub>SI</sub> Decreasing = 1.5 V to 1.0 V)	V <sub>SOth</sub>	1.16	1.23	1.35	V
Sense Threshold Hysteresis	V <sub>SOth,hys</sub>	20	100	200	mV
Sense Output Low Voltage (V <sub>SI</sub> $\leq$ 1.16 V, V <sub>CC</sub> $\geq$ 3.0 V, R <sub>SO</sub> = 10 k $\Omega$ to V <sub>out</sub> )	V <sub>SOL</sub>	_	_	0.4	V
Sense Output Leakage (V <sub>SO</sub> = 5.0 V, V <sub>SI</sub> ≥ 1.5 V)	I <sub>SOH</sub>	-	-	1.0	μΑ
Sense Input Current	I <sub>SI</sub>	-1.0	0.1	1.0	μΑ
PREREGULATOR	1	1	1		
Preregulator Output Voltage (I <sub>Z</sub> = 10 μA)	Vz	_	6.3	_	V

## PIN FUNCTION DESCRIPTION

Pin SOIC-8, PDIP-8	Pin SOIC-8 EP	Pin SOIC-20W	Symbol	Description
1	1	19	V <sub>CC</sub>	Supply Voltage
2	2	20	S <sub>i</sub>	Input of Sense Comparator
3	3	1	V <sub>Z</sub>	Output of Preregulator
4	4	2	C <sub>T</sub>	Reset Delay Capacitor
5	5	4 – 7, 14 – 17	GND	Ground
6	6	10	Reset	Output of Reset Comparator
7	7	11	S <sub>O</sub>	Output of Sense Comparator
8	8	12	V <sub>out</sub>	Main Regulator Output
-	-	3, 8, 9, 13, 18	NC	No Connect
-	EPAD	-	EPAD	Connect to Ground potential or leave unconnected

#### **TYPICAL CHARACTERIZATION CURVES**

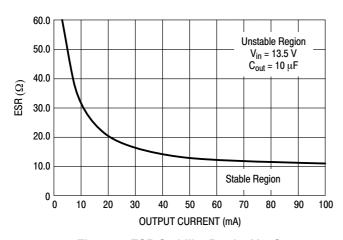


Figure 2. ESR Stability Border Vs. Output Current (Full ESR Range)

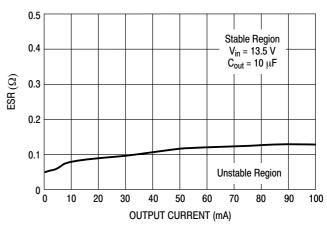


Figure 3. ESR Stability Border Vs. Output Current (Very Low ESR)

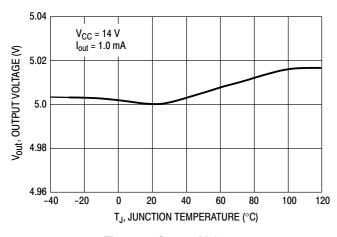


Figure 4. Output Voltage versus Junction Temperature

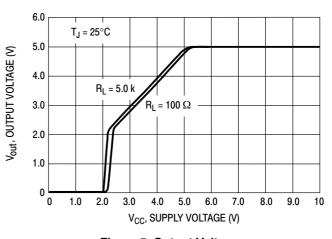


Figure 5. Output Voltage versus Supply Voltage

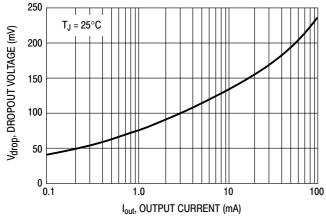


Figure 6. Dropout Voltage versus
Output Current

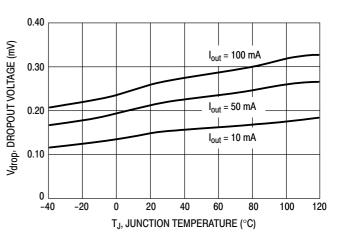


Figure 7. Dropout Voltage versus Junction Temperature

#### TYPICAL CHARACTERIZATION CURVES (continued)

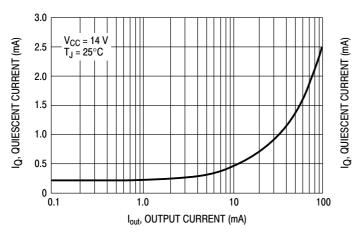


Figure 8. Quiescent Current versus
Output Current

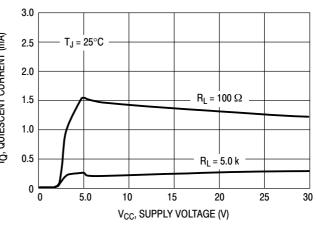


Figure 9. Quiescent Current versus Supply Voltage

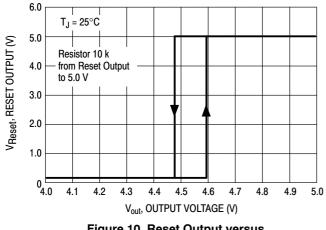


Figure 10. Reset Output versus Regulator Output Voltage

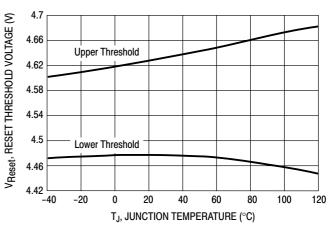


Figure 11. Reset Thresholds versus Junction Temperature

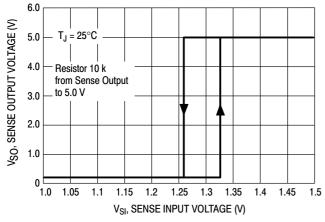


Figure 12. Sense Output versus Sense Input Voltage

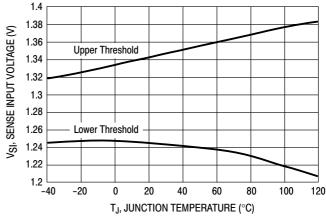


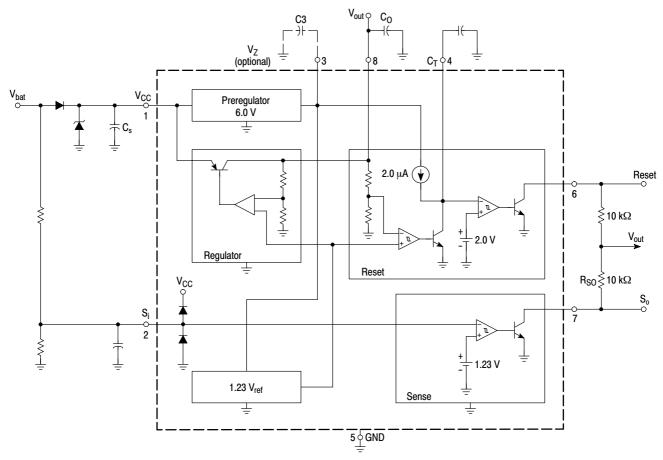
Figure 13. Sense Thresholds versus Junction Temperature

#### **APPLICATION INFORMATION**

#### **Supply Voltage Transient**

High supply voltage transients can cause a reset output signal perturbation. For supply voltages greater than 8.0 V the circuit shows a high immunity of the reset output against supply transients of more than 100 V/µs. For supply voltages

less than 8.0 V supply transients of more than 0.4 V/ $\mu s$  can cause a reset signal perturbation. To improve the transient behavior for supply voltages less than 8.0 V a capacitor at Pin 3 can be used. A capacitor at Pin 3 (C3  $\leq$  1.0  $\mu$ F) also reduces the output noise.



NOTE: 1. For stability:  $C_s \ge 1.0~\mu\text{F},~C_O \ge 4.7~\mu\text{F},~ESR < 10~\Omega$  at 10 kHz 2. Recommended for application:  $C_s = C_O = 10~\mu\text{F}$ 

Figure 14. Application Schematic

#### **OPERATING DESCRIPTION**

The L4949 is a monolithic integrated low dropout voltage regulator. Several outstanding features and auxiliary functions are implemented to meet the requirements of supplying microprocessor systems in automotive applications. It is also suitable in other applications where the included functions are required. The modular approach of this device allows the use of other features and functions independently when required.

#### **Voltage Regulator**

The voltage regulator uses an isolated collector vertical PNP transistor as a regulating element. With this structure, very low dropout voltage at currents up to 100 mA is obtained. The dropout operation of the standby regulator is maintained down to 3.0 V input supply voltage. The output voltage is regulated up to a transient input supply voltage of 35 V.

A typical curve showing the standby output voltage as a function of the input supply voltage is shown in Figure 16.

The current consumption of the device (quiescent current) is less than 200  $\mu A$ .

To reduce the quiescent current peak in the undervoltage region and to improve the transient response in this region, the dropout voltage is controlled. The quiescent current as a function of the supply input voltage is shown in Figure 17.

#### Short Circuit Protection:

The maximum output current is internally limited. In case of short circuit, the output current is foldback current limited as described in Figure 15.

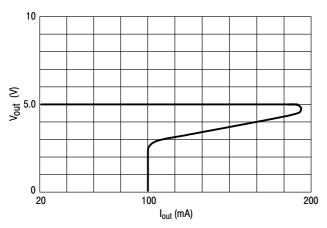


Figure 15. Foldback Characteristic of Vout

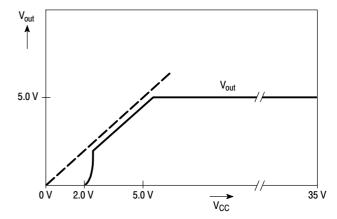


Figure 16. Output Voltage versus Supply Voltage

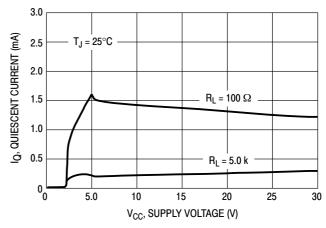


Figure 17. Quiescent Current versus Supply Voltage

#### Preregulator

To improve transient immunity a preregulator stabilizes the internal supply voltage to 6.0 V. This internal voltage is present at Pin 3 ( $V_Z$ ). This voltage should not be used as an output because the output capability is very small ( $\leq 100 \, \mu A$ ).

This output may be used to improve transient behavior for supply voltages less than 8.0 V. In this case a capacitor (100 nF  $-1.0 \mu$ F) must be connected between Pin 3 and GND. If this feature is not used Pin 3 must be left open.

#### **Reset Circuit**

The block circuit diagram of the reset circuit is shown in Figure 18.

The reset circuit supervises the output voltage. The reset threshold of 4.5 V is defined by the internal reference voltage and standby output divider.

The reset pulse delay time  $t_{RD}$ , is defined by the charge time of an external capacitor  $C_T$ :

$$t_{RD} = \frac{C_T \, x \, 2.0 \, V}{2.0 \, \mu A}$$

The reaction time of the reset circuit originates from the discharge time limitation of the reset capacitor  $C_T$  and is proportional to the value of  $C_T$ . The reaction time of the reset circuit increases the noise immunity.

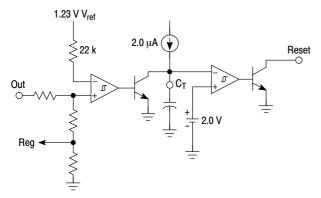


Figure 18. Reset Circuit

Output voltage drops below the reset threshold only marginally longer than the reaction time results in a shorter reset delay time.

The nominal reset delay time will be generated for output voltage drops longer than approximately 50 µs. The typical reset output waveforms are shown in Figure 19.

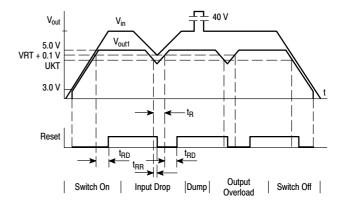


Figure 19. Typical Reset Output Waveforms

#### **Sense Comparator**

The sense comparator compares an input signal with an internal voltage reference of typical 1.23 V. The use of an external voltage divider makes this comparator very flexible in the application.

It can be used to supervise the input voltage either before or after a protection diode and to provide additional information to the microprocessor such as low voltage warnings.

## **ORDERING INFORMATION**

Device	Operating Temperature Range	Package	Shipping <sup>†</sup>
L4949NG		PDIP-8 (Pb-Free)	50 Units / Rail
L4949DG		SOIC-8 (Pb-Free)	98 Units / Rail
L4949DR2G		SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
NCV4949DG*		SOIC-8 (Pb-Free)	98 Units / Rail
NCV4949PDG*	$T_{J} = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	SOIC-8 EP (Pb-Free)	98 Units / Rail
NCV4949DR2G*		SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
NCV4949PDR2G*		SOIC-8 EP (Pb-Free)	2500 Units / Tape & Reel
NCV4949DWR2G*		SOIC-20W (Pb-Free)	1000 Units / Tape & Reel

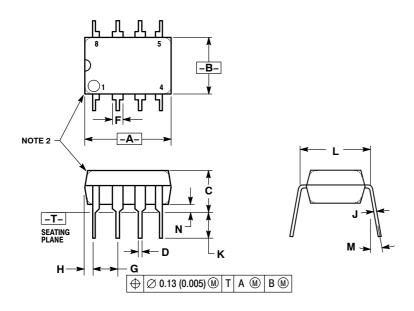
<sup>†</sup>For information on tape and reel specifications,including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NCV4949: T<sub>low</sub> = -40°C, T<sub>high</sub> = +125°C. Guaranteed by design.

NCV prefix is for automotive and other applications requiring site and change control.

#### PACKAGE DIMENSIONS

#### **N SUFFIX** PLASTIC PACKAGE CASE 626-05 **ISSUE L**

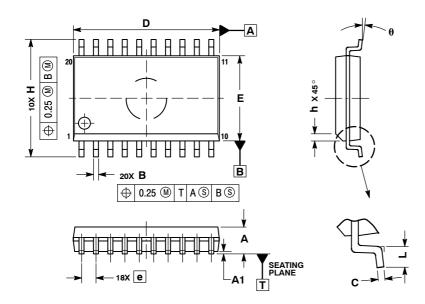


- NOTES:
  1. DIMENSION L TO CENTER OF LEAD WHEN
- FORMED PARALLEL.
  2. PACKAGE CONTOUR OPTIONAL (ROUND OR
- SQUARE CORNERS).

  3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.40	10.16	0.370	0.400
В	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54	BSC	0.100 BSC	
Н	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300	BSC
M		10°		10°
N	0.76	1.01	0.030	0.040

#### SOIC-20 WB **DW SUFFIX** CASE 751D-05 **ISSUE G**



- NOTIES:

  1. DIMENSIONS ARE IN MILLIMETERS.

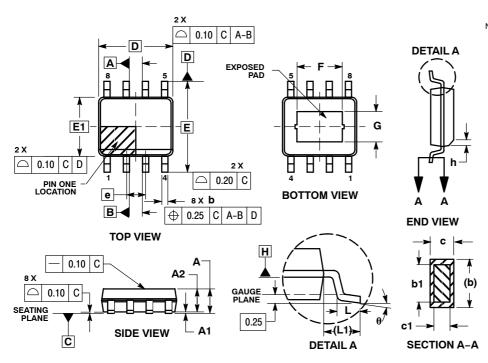
  2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTEINSION.
- PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS			
DIM	MIN	MAX		
Α	2.35	2.65		
A1	0.10	0.25		
В	0.35	0.49		
С	0.23	0.32		
D	12.65	12.95		
E	7.40	7.60		
е	1.27	BSC		
Н	10.05	10.55		
h	0.25	0.75		
L	0.50	0.90		
A	n٥	7 0		

#### PACKAGE DIMENSIONS

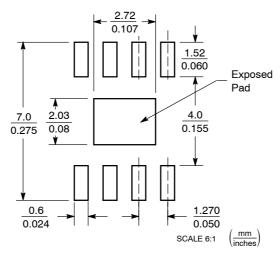
#### SOIC-8 EP **PD SUFFIX** CASE 751AC-01 **ISSUE B**



- NOTES:
  1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
  2. DIMENSIONS IN MILLIMETERS (ANGLES
- 2. DIMENSIONS IN MILLIMETERS (ANGLE IN DEGREES).
  3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE "b" DIMENSION AT MAXIMUM MATERIAL ON DITION. CONDITION.
- DATUMS A AND B TO BE DETERMINED AT DATUM PLANE H.

	MILLIN	IETERS
DIM	MIN	MAX
Α	1.35	1.75
<b>A</b> 1	0.00	0.10
A2	1.35	1.65
b	0.31	0.51
b1	0.28	0.48
С	0.17	0.25
c1	0.17	0.23
D	4.90	BSC
Е	6.00	BSC
E1	3.90	BSC
е	1.27	BSC
L	0.40	1.27
L1	1.04	REF
F	2.24	3.20
G	1.55	2.51
h	0.25	0.50
θ	0 °	8°

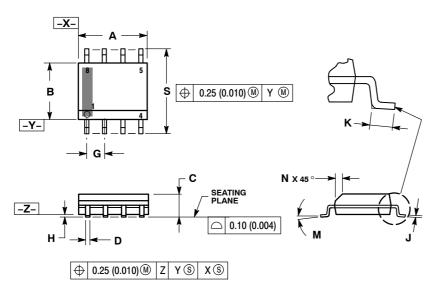
#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **PACKAGE DIMENSIONS**

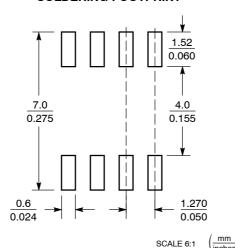
SOIC-8 NB CASE 751-07 **ISSUE AJ** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	1.27 BSC		0 BSC
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice on semiconductor and are registered readerlands of semiconductor Components industries, Ite (SCILLC) . Solitude services are inject to make triangles without further holice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# **ON Semiconductor:**

NCV4949DR2 NCV4949DR2G NCV4949DWR2 NCV4949DWR2G L4949D L4949DG L4949DR2 L4949DR2G L4949DR NCV4949PDR NCV4949PDR2G NCV4949DG